

KAA-3528SURKSYKCT

3.5 x 2.8 mm Surface Mount LED Lamp

DESCRIPTIONS

- The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode
- The Super Bright Yellow device is made with AlGaInP (on GaAs substrate) light emitting diode chip
- · Electrostatic discharge and power surge could damage the LEDs
- . It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- · All devices, equipments and machineries must be electrically grounded

FEATURES

- · Suitable for all SMD assembly and solder process
- · Available on tape and reel
- Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- RoHS compliant

APPLICATIONS

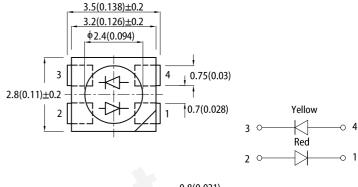
- Backlight
- · Status indicator
- · Home and smart appliances
- · Wearable and portable devices
- Healthcare applications

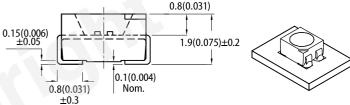
ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices



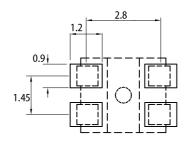
PACKAGE DIMENSIONS





RECOMMENDED SOLDERING PATTERN

(units: mm: tolerance: + 0.1)



- 1. All dimensions are in millimeters (inches)
- 2. Tolerance is ±0.25(0.01") unless otherwise noted.
 3. The specifications, characteristics and technical data described in the datasheet are subject to
- change without prior notice.

 4. The device has a single mounting surface. The device must be mounted according to the specifications.

SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	Iv (mcd) @ 20mA [2]		Viewing Angle [1]	
			Min.	Тур.	2θ1/2	
KAA-3528SURKSYKCT	■ Hyper Red (AlGalnP)	- Water Clear	200	320		
			*55	*100	120°	
	Super Bright Yellow (AlGalnP)		120	240		
			*120	*240		

Notes.

1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

2. Luminous intensity / luminous flux: +/-15%.

* Luminous intensity value is traceable to CIE127-2007 standards.





ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Emitting Color	Value		Unit
, aramoto			Тур.	Max.	J
Wavelength at Peak Emission I _F = 20mA	λ_{peak}	Hyper Red Super Bright Yellow	645 590	-	nm
Dominant Wavelength I _F = 20mA	λ _{dom} ^[1]	Hyper Red Super Bright Yellow	630 590	-	nm
Spectral Bandwidth at 50% Φ REL MAX I _F = 20mA	Δλ	Hyper Red Super Bright Yellow	28 20	-	nm
Capacitance	С	Hyper Red Super Bright Yellow	35 20	-	pF
Forward Voltage I _F = 20mA	V _F ^[2]	Hyper Red Super Bright Yellow	1.95 2.0	2.5 2.5	V
Reverse Current (V _R = 5V)	I _R	Hyper Red Super Bright Yellow	-	10 10	uA
Temperature Coefficient of λ_{peak} I_F = 20mA, -10°C $\leq~T \leq 85^{\circ}C$	TC_{\lambdapeak}	Hyper Red Super Bright Yellow	0.14 0.12	-	nm/°C
Temperature Coefficient of λ_{dom} I _F = 20mA, -10°C $\leq T \leq 85$ °C	TC_{\lambdadom}	Hyper Red Super Bright Yellow	0.05 0.07	-	nm/°C
Temperature Coefficient of V_F I_F = 20mA, -10°C $\leq T \leq 85$ °C	TC _V	Hyper Red Super Bright Yellow	-1.9 -1.9	-	mV/°C

Notes:

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

Parameter	Symbol	Va	Unit	
		Hyper Red	Super Bright Yellow	
Power Dissipation	P_D	75	75	mW
Reverse Voltage	V _R	5 5		V
Junction Temperature	TJ	115	115	°C
Operating Temperature	T _{op}	-40 To +85		
Storage Temperature	T _{stg}	-40 To +85		°C
DC Forward Current	I _F	30	30 30	
Peak Forward Current	I _{FM} ^[1]	185	175	mA
Electrostatic Discharge Threshold (HBM)	-	3000 3000		V
Thermal Resistance (Junction / Ambient)	R _{th JA} ^[2]	320 320		°C/W
Thermal Resistance (Junction / Solder point)	R _{th JS} [2]	210 190		°C/W

Notes:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

2. R_{th. JA}, R_{th. JS} Results from mounting on PC board FR4 (pad size ≥ 16 mm² per pad).

3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

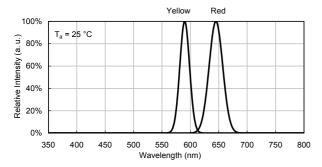


The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd:±1nm.)
 Forward voltage: ±0.1V.
 Wavelength value is traceable to CIE127-2007 standards.
 Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

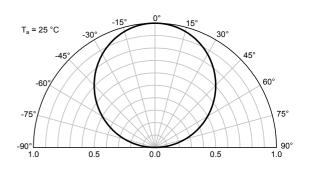


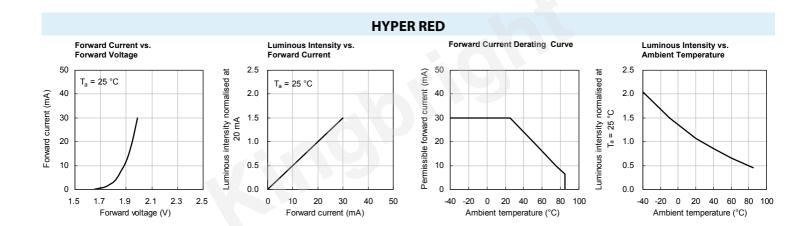
TECHNICAL DATA

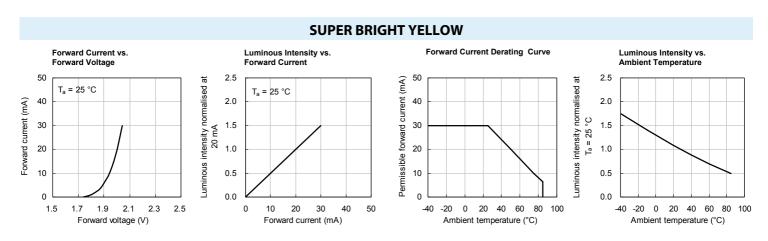
RELATIVE INTENSITY vs. WAVELENGTH



SPATIAL DISTRIBUTION

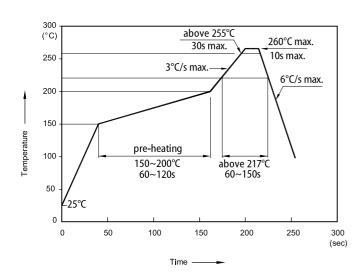








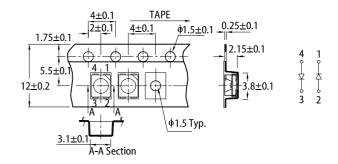
REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS



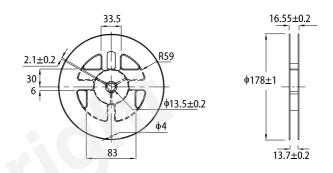
- Don't cause stress to the LEDs while it is exposed to high temperature
 The maximum number of reflow soldering.
- The maximum number of reflow soldering passes is 2 times.

 Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

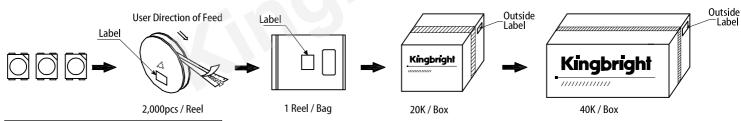
TAPE SPECIFICATIONS (units: mm)



REEL DIMENSION (units: mm)



PACKING & LABEL SPECIFICATIONS





PRECAUTIONARY NOTES

- The information included in this document reflects representative usage scenarios and is intended for technical reference only
- The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If
- customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.

 The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance.
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